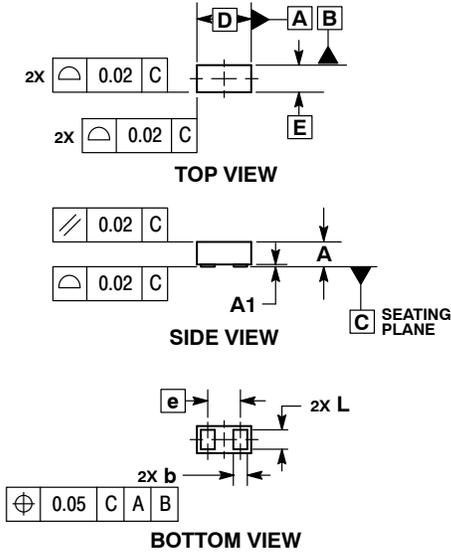




SCALE 12:1

WLCSP2, 0.6x0.3
CASE 567AV
ISSUE C

DATE 22 SEP 2017



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.

| MILLIMETERS | | | |
|-------------|----------|-------|-------|
| DIM | MIN | NOM | MAX |
| A | 0.250 | 0.275 | 0.300 |
| A1 | 0.000 | 0.025 | 0.050 |
| b | 0.140 | 0.155 | 0.170 |
| D | 0.570 | 0.600 | 0.630 |
| E | 0.270 | 0.300 | 0.330 |
| e | 0.36 BSC | | |
| L | 0.190 | 0.215 | 0.240 |

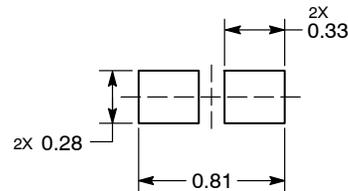
GENERIC MARKING DIAGRAM*



X = Specific Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED SOLDER FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| | | |
|-------------------------|------------------------|--|
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| DESCRIPTION: | WLCSP2, 0.6X0.3 | PAGE 1 OF 1 |

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